

PATENT

Attorney Reference Number 245-68071-01

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of: Paul et al.**Application No.** 10/803,502**Filed:** March 17, 2004**Confirmation No.** 5691**For:** METHOD FOR MAKING DEVICES
HAVING INTERMETALLIC
STRUCTURES AND INTERMETALLIC
DEVICES MADE THEREBY**Examiner:** Unknown**Art Unit:** 3729**Attorney Reference No.** 245-68071-01CERTIFICATE OF MAILING

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Attorney
for Applicant(s)Date Mailed April 8, 2005COMMISSIONER FOR PATENTS
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ALEXANDRIA, VA 22313-1450TRANSMITTAL LETTER

Enclosed for filing in the application referenced above are the following:

- ☒ Information Disclosure Statement
☒ Form 1449 and references cited thereon
- ☒ The Director is hereby authorized to charge any additional fees that may be required, or credit over-payment, to Deposit Account No. 02-4550. A copy of this sheet is enclosed.
- ☒ Please return the enclosed postcard to confirm that the items listed above have been received.

Respectfully submitted,

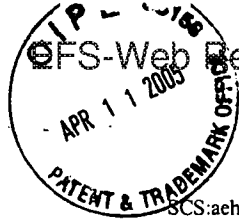
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By

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Registration No. 36,011

cc: Docketing



Receipt date: 04/11/2005

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INFORMATION DISCLOSURE STATEMENT
PURSUANT TO 37 C.F.R. § 1.97(b)(3)

COMMISSIONER FOR PATENTS
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Listed on the accompanying form PTO-1449 and enclosed herewith are several English-language documents. Applicants respectfully request that these documents be listed as references cited on the issued patent.

Copies of United States patents and United States published patent applications do not have to be provided to the Patent Office (37 C.F.R. 1.98(a)(2)(ii)). Copies of unpublished U.S. applications do not have to be provided, as long as the application is available on PAIR, as this requirement of 37 C.F.R. § 1.98(a)(2)(iii) has been waived by the United States Patent and Trademark Office pursuant to the Official Gazette Notice on October 19, 2004 (1287 OG 163). Applicants will provide copies of such patents or applications upon request.

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PATENT


Applicants filed this Information Disclosure Statement ("IDS") before the mailing date of a first Office action on the merits. As a result, no fee should be required to file this IDS. However, if the Patent Office determines that a fee is required for Applicants to file this IDS, please charge any such fees, or credit overpayment, to Deposit Account No. 02-4550. A **duplicate** copy of this Information Disclosure Statement is enclosed.

The filing of this IDS shall not be construed to be an admission that the information cited in the statement is, or is considered to be, prior art or otherwise material to patentability as defined in 37 C.F.R. §1.56.

Respectfully submitted,

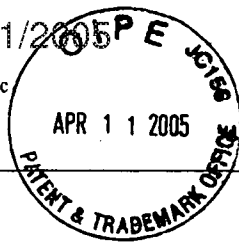
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INFORMATION DISCLOSURE STATEMENT BY APPLICANT

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Filing Date	March 17, 2004
First Named Inventor	Paul
Art Unit	3729
Examiner Name	Unknown

U.S. PATENT DOCUMENTS

NOTE: If this application was filed after June 30, 2003, copies of United States patents and United States published patent applications do not have to be provided to the Patent Office. This requirement of 37 C.F.R. § 1.98(a)(2)(i) has been waived by the United States Patent and Trademark Office pursuant to the Official Gazette Notice on August 5, 2003 (1276 OG 55).

Examiner's Initials*	Cite No. (optional)	Number	Publication Date	Name of Applicant or Patentee
/N.D./		4,647,748	3/1987	Glassman
		4,875,619	10/1989	Anderson et al.
		5,087,930	2/1992	Roy et al.
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		5,985,068	11/1999	Kawakami et al.
		6,048,432	4/2000	Ecer

EXAMINER
SIGNATURE:

/Nicholas D'aniello/

DATE

05/27/2008

CONSIDERED:

* Examiner: Initial if reference considered, whether or not in conformance with MPEP 609. Draw line through cite if not in conformance and not considered. Include copy of this form with next communication to applicant.

INFORMATION DISCLOSURE STATEMENT BY APPLICANT				Attorney Docket Number	245-68071-01
				Application Number	10/803,502
				Filing Date	March 17, 2004
				First Named Inventor	Paul
				Art Unit	3729
				Examiner Name	Unknown
/N.D./		6,100,463	8/2000	Ladd et al.	
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/N.D./		"Technology Development Through Industrial Partnerships," <i>Federal Energy Technology Center</i> , 10 pages, October 1997.			
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		Hershberg, "Manufacturing Technology of the Tektronix Digital Ink Jet Head," <i>SPSE3rd International Congress on Advanced in Non-Impact Printing Technologies, Journal of Imaging Technology</i> , Vol. 14, pages 124-128, 1998.			
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/N.D./		Kleiner, "High Performance Forced Air Cooling Scheme Employing Microchannel Heat Exchangers," <i>IEEE Transactions on Components, Packaging, and Manufacturing Technology</i> , Vol. 18, No. 4, pages 795-804, December 1995.	
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